

L Number	Hits	Search Text	DB	Time stamp
1	8345	(micromirror\$1 or micro-mirror\$1 or (micro adj2 mirror\$1))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:46
2	314411	(substrate\$1 or wafer\$1 or template\$1) with silicon\$2	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:47
3	57617	circuit\$2 with CMOS	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:47
4	1390637	electrode\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:47
5	489892	hinge\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:47
6	193578	polygon or rectangle or hexagon	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:48
7	1646445	stop\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:48
8	1617	(359/290,291,292,294,295,298,318).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:49
9	1949	((micromirror\$1 or micro-mirror\$1 or (micro adj2 mirror\$1))) and ((substrate\$1 or wafer\$1 or template\$1) with silicon\$2)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:49
10	270	(circuit\$2 with CMOS) and (((micromirror\$1 or micro-mirror\$1 or (micro adj2 mirror\$1))) and ((substrate\$1 or wafer\$1 or template\$1) with silicon\$2))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:49
11	189	electrode\$1 and ((circuit\$2 with CMOS) and (((micromirror\$1 or micro-mirror\$1 or (micro adj2 mirror\$1))) and ((substrate\$1 or wafer\$1 or template\$1) with silicon\$2)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:50
12	125	hinge\$1 and (electrode\$1 and ((circuit\$2 with CMOS) and (((micromirror\$1 or micro-mirror\$1 or (micro adj2 mirror\$1))) and ((substrate\$1 or wafer\$1 or template\$1) with silicon\$2))))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:50
13	18	(polygon or rectangle or hexagon) and (hinge\$1 and (electrode\$1 and ((circuit\$2 with CMOS) and (((micromirror\$1 or micro-mirror\$1 or (micro adj2 mirror\$1))) and ((substrate\$1 or wafer\$1 or template\$1) with silicon\$2))))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:50
14	11	stop\$3 and ((polygon or rectangle or hexagon) and (hinge\$1 and (electrode\$1 and ((circuit\$2 with CMOS) and (((micromirror\$1 or micro-mirror\$1 or (micro adj2 mirror\$1))) and ((substrate\$1 or wafer\$1 or template\$1) with silicon\$2))))))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:50

15	3	((359/290,291,292,294,295,298,318).CCLS.) and (stop\$3 and ((polygon or rectangle or hexagon) and (hinge\$1 and (electrode\$1 and ((circuit\$2 with CMOS) and (((micromirror\$1 or micro-mirror\$1 or (micro adj2 mirror\$1))) and ((substrate\$1 or wafer\$1 or template\$1) with silicon\$2))))))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/10/21 10:50
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